FDMC89521L Dual N-Channel PowerTrench[®] MOSFET 60 V, 8.2 A, 17 mΩ

Features

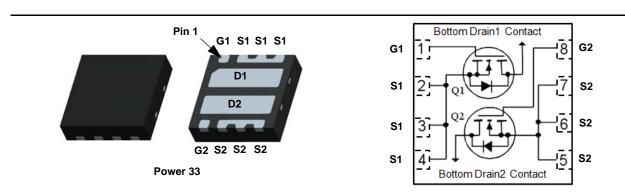
- Max $r_{DS(on)}$ = 17 m Ω at V_{GS} = 10 V, I_D = 8.2 A
- Max $r_{DS(on)}$ = 27 m Ω at V_{GS} = 4.5 V, I_D = 6.7 A
- Termination is Lead-free
- RoHS Compliant



This device includes two 60 V N-Channel MOSFETs in a dual Power 33 (3 mm X 3 mm MLP) package. The package is enhanced for exceptional thermal performance.

Applications

- Battery Protection
- Load Switching
- Bridge Topologies



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
1	Drain Current -Continuous	T _A = 25 °C	(Note 1a)	8.2	•	
D	-Pulsed			40	— A	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	32	mJ	
D	Power Dissipation	T _A = 25 °C	(Note 1a)	1.9	w	
PD	Power Dissipation	T _A = 25 °C	(Note 1b)	0.8	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	65	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	155	0/10

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC89521L	FDMC89521L	Power 33	13 "	12 mm	3000 units

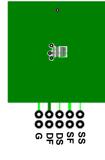
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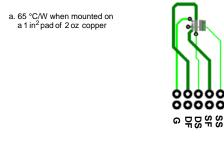
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60		1	V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		30		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Chara	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
•		V _{GS} = 10 V, I _D = 8.2 A		13	17	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 6.7 \text{ A}$		21	27	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 8.2 \text{ A},$ T _J = 125 °C		20	26	
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 8.2 \text{ A}$		28		S
C _{iss}	Characteristics Input Capacitance			1228	1635	pF
C _{oss}	Output Capacitance	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V},$ = 1 MHz		243	325	pF
C _{rss}	Reverse Transfer Capacitance			10	15	pF
Rg	Gate Resistance			0.7		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			7.9	16	ns
t _r	Rise Time	$V_{DD} = 30 V, I_D = 8.2 A,$		2.1	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		18	33	ns
t,	Fall Time			1.7	10	ns
				17	04	
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		17	24	nC
Q _g Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$		7.9	24 12	nC
Q _g Q _g	Total Gate Charge Gate to Source Charge			7.9 3.8		
Q _g Q _g Q _{gs}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$		7.9		nC
Q _g Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate to Source Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$		7.9 3.8		nC nC
t _f <u>Qg</u> <u>Qgs</u> Qgd Drain-So V _{SD}	Total Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 30 V,$		7.9 3.8		nC nC

Brain					
V	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 8.2 A$ (Note 2)	0.85	1.3	V
V _{SD}	Source-Drain Diode Torward Voltage	$V_{GS} = 0 V, I_{S} = 1.6 A$ (Note 2)	0.75	1.2	v
t _{rr}	Reverse Recovery Time	I _F = 8.2 A, di/dt = 100 A/μs	25	40	ns
Q _{rr}	Reverse Recovery Charge	$F = 0.2 \text{ A}, \text{ u/ut} = 100 \text{ A/}\mu\text{s}$	11	20	nC

Notes:

1. R_{01A} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.





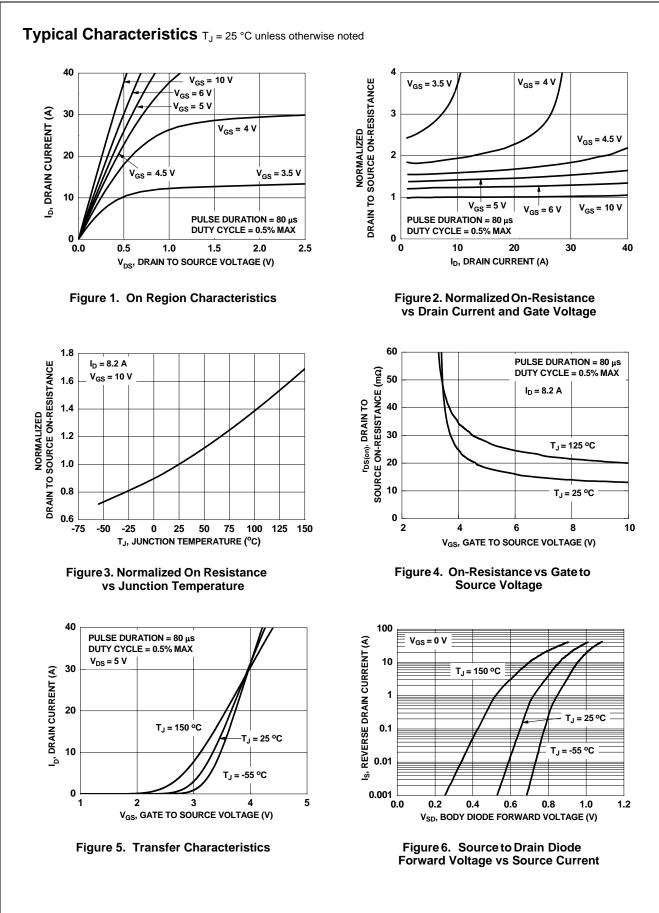
b. 155 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

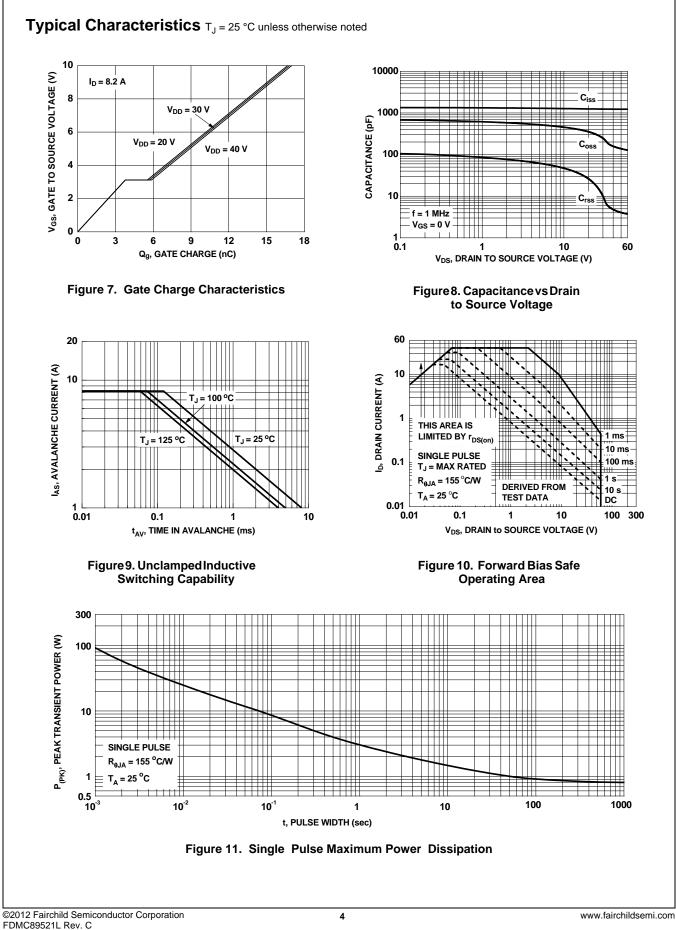
3. E_{AS} of 32 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 8 A, V_{DD} = 54 V, V_{GS} = 10 V. 100% tested at L = 3 mH, I_{AS} = 5.4 A.

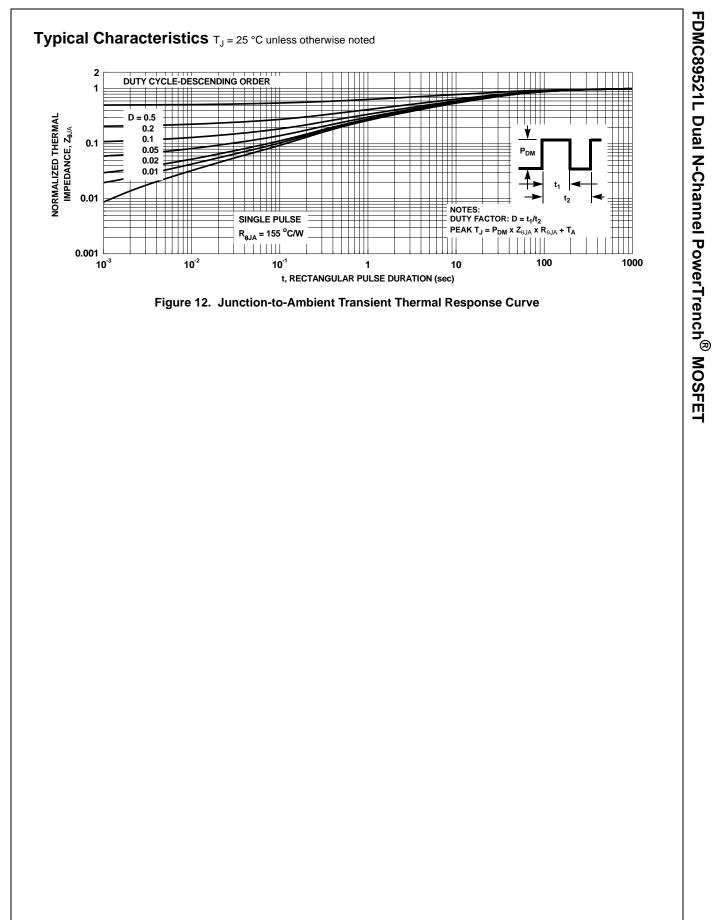
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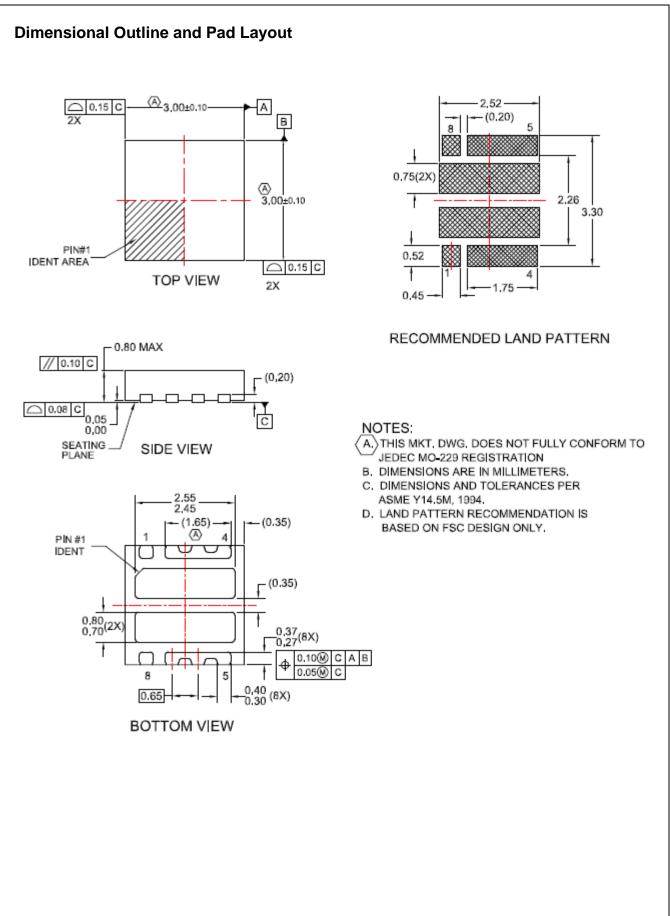
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